Display Elektronik GmbH

DATA SHEET

LCD-MODULE

DEM 20235 FGH-PW

Product Specification   **Ver.: 3**

25.02.2016

Revision History

VERSION	DATE	Note
0	19.07.2011	First Issue
1	24.11.2014	Remove IC Information
		Modify Response Time & B/L Information
2	26.06.2015	Modify Backlight Information
3	25.02.2016	Modify Precautions in use of LCD Modules
		& Static Electricity Test

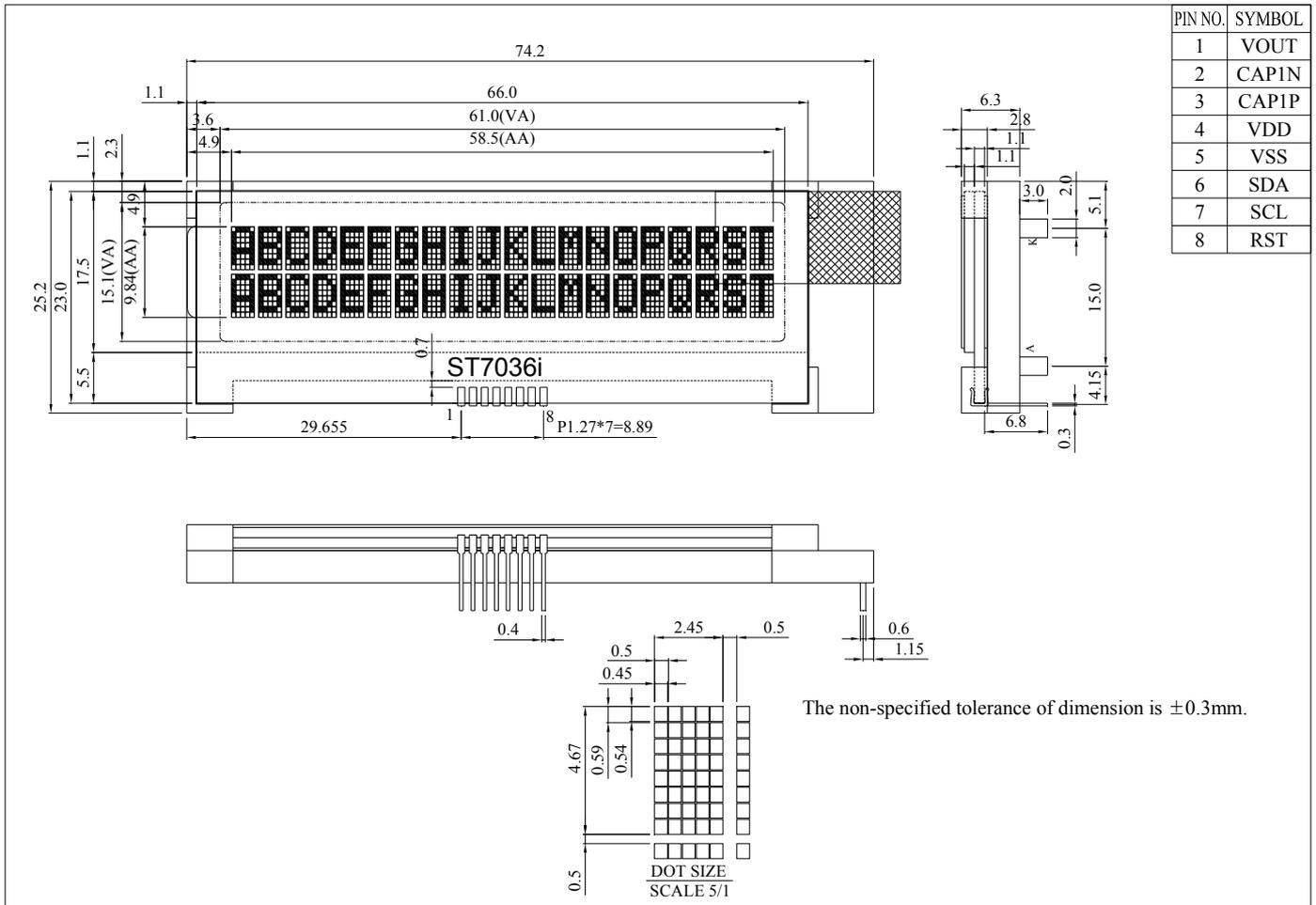# Contents

1. General Specification

The Features is described as follow:

- Module Dimension: 74.20 x 25.20 x 6.30 mm

- View Area: 61.00 x 15.10 mm

- Active Area: 58.50 x 9.84 mm

- Number of Characters: 20 Characters x 2 Lines

- Dot Size: 0.45 x 0.54 mm

- Dot Pitch: 0.50 x 0.59 mm

- Character Size：2.45 x 4.67 mm

- Character Pitch：2.95 x 5.17 mm

- LCD Type: FSTN Positive Transflective

- Duty: 1/16DUTY,1/5BIAS

- View Direction: 6 o'clock

- Backlight Type: LED White

- IC: ST7036i (Sitronix)
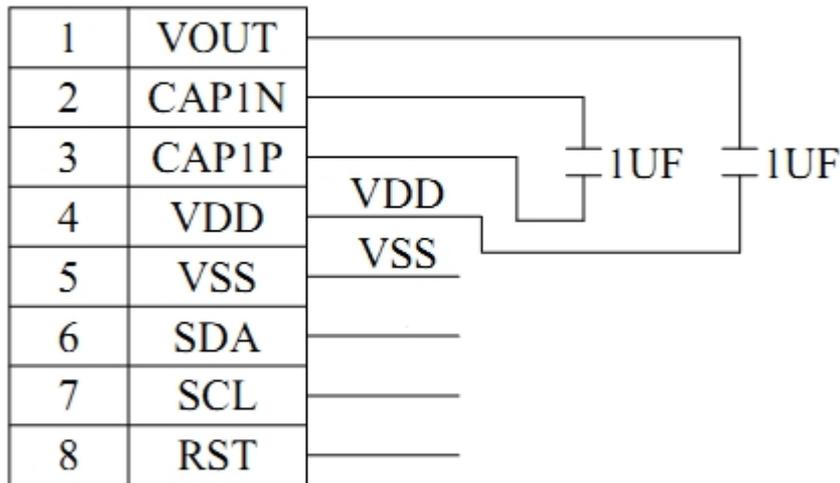
2. Interface Pin Function

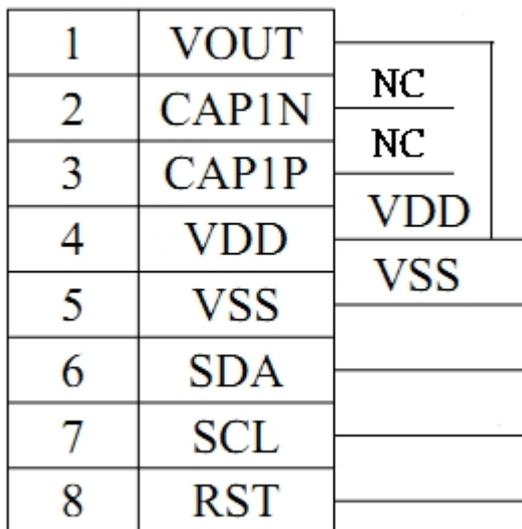| Pin No.	Symbol	Level	Description
1	VOUT		DC/DC voltage converter. Connect a capacitor between this terminal and VIN when the built-in booster is used.
2	CAP1N		For voltage booster circuit(VDD-VSS)
3	CAP1P		External capacitor about 0.1u~4.7uf
4	VDD	3.0/5.0V	Power supply
5	VSS		GND
6	SDA		(In I2C interface DB7 (SDA) is input data. SDA and SCL must connect to I2C bus (I2C bus is to connect a resister between SDA/SCL and the power of I2C bus).
7	SCL		(In I2C interface DB6 (SCL) is clock input. SDA and SCL must connect to I2C bus (I2C bus is to connect a resister between SDA/SCL and the power of I2C bus).
8	RST		RESET

3. Counter Drawing

PIN NO.	SYMBOL
1	VOUT
2	CAP1N
3	CAP1P
4	VDD
5	VSS
6	SDA
7	SCL
8	RST

ST7036i

The non-specified tolerance of dimension is ± 0.3mm.

DOT SIZE
SCALE 5/1

Application schematic

VDD=3.0V

1	VOUT
2	CAP1N
3	CAP1P
4	VDD
5	VSS
6	SDA
7	SCL
8	RST

VDD
VSS
1UF   1UF

VDD=5.0V

1	VOUT
2	CAP1N
3	CAP1P
4	VDD
5	VSS
6	SDA
7	SCL
8	RST

NC
NC
VDD
VSS

INITIALIZE: (3V)

```
        MOV     I2C_CONTROL,#00H ;WRITE COMMAND
        MOV     I2C_DATA,#38H       ;Function Set
        LCALL   WRITE_CODE
        MOV     I2C_CONTROL,#00H ;WRITE COMMAND
        MOV     I2C_DATA,#39H       ;Function Set
        LCALL   WRITE_CODE
        MOV     I2C_DATA,#14H       ;Internal OSC frequency
        LCALL   WRITE_CODE
        MOV     I2C_DATA,#74H       ;Contrast set
        LCALL   WRITE_CODE
        MOV     I2C_DATA,#54H            ;Power/ICON control/Contrast set
        LCALL   WRITE_CODE
        MOV     I2C_DATA,#6FH            ;Follower control
        LCALL   WRITE_CODE
        MOV     I2C_DATA,#0CH       ;Display ON/OFF
        LCALL   WRITE_CODE
        MOV     I2C_DATA,#01H       ;Clear Display
        LCALL   WRITE_CODE
```
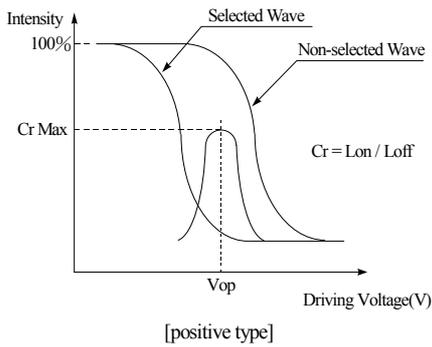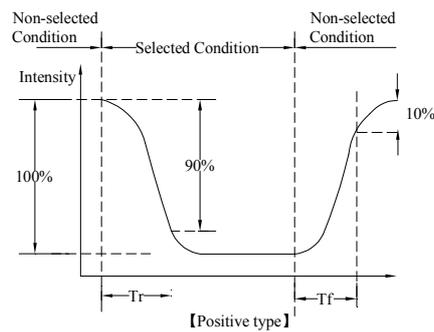
INITIALIZE: (5V)

```
MOV      I2C_CONTROL,#00H;WRITE COMMAND

MOV      I2C_DATA,#38H      ;Function Set

LCALL    WRITE_CODE

MOV      I2C_CONTROL,#00H;WRITE COMMAND

MOV      I2C_DATA,#39H      ;Function Set

LCALL    WRITE_CODE

MOV      I2C_DATA,#14H      ;Internal OSC frequency

LCALL    WRITE_CODE

MOV      I2C_DATA,#79H      ;Contrast set

LCALL    WRITE_CODE

MOV      I2C_DATA,#50H          ;Power/ICON control/Contrast set

LCALL    WRITE_CODE

MOV      I2C_DATA,#6CH          ;Follower control

LCALL    WRITE_CODE

MOV      I2C_DATA,#0CH      ;Display ON/OFF

LCALL    WRITE_CODE

MOV      I2C_DATA,#01H      ;Clear Display

LCALL    WRITE_CODE
```

4. Optical Characteristics

Item	Symbol	Condition	Min	Typ	Max	Unit
View Angle	θ	CR≧2	0	—	30	ψ= 180°
	θ	CR≧2	0	—	60	ψ= 0°
	θ	CR≧2	0	—	45	ψ= 90°
	θ	CR≧2	0	—	45	ψ= 270°
Contrast Ratio	CR	—	—	5	—	—
Response Time	T Rise	—	—	150	200	ms
	T Fall	—	—	150	200	ms

Definition of Operation Voltage (Vop)   **Definition of Response Time (Tr , Tf)**

Intensity
100%   Selected Wave
              Non-selected Wave
Cr Max   Cr = Lon / Loff
              Vop
                          Driving Voltage(V)
[positive type]

Non-selected Condition —— Selected Condition —— Non-selected Condition
Intensity
100%   90%   10%
              Tr   Tf
【Positive type】

Conditions :

Operating Voltage : Vop   Viewing Angle(θ，φ) : 0°， 0°

Frame Frequency : 64 Hz Driving Waveform : 1/N duty , 1/a bias

Definition of viewing angle (CR≧2)

θ b
θ f
θ 1   θ r   φ = 180°
φ = 270°   φ = 90°
φ = 0°
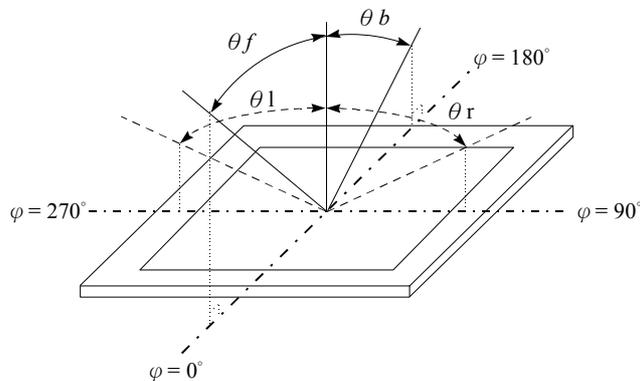
5. Absolute Maximum Ratings

Item	Symbol	Min	Typ	Max	Unit
Operating Temperature	T_{OP}	-20	—	+70	°C
Storage Temperature	T_{ST}	-30	—	+80	°C
Input Voltage	V_{IN}	-0.3	—	V_{DD} +0.3	V
Power Supply Voltage	V_{DD}	-0.3	—	+7.0	V
LCD Driver Voltage	V_{LCD}	7.0- V_{SS}	—	-0.3+ V_{SS}	V

6. Electrical Characteristics

Item	Symbol	Condition	Min	Typ	Max	Unit
Supply Voltage For Logic	V_{DD}-V_{SS}	—	3	3.3	5 (bon=1 max=3.5V)	V
Supply Voltage For LCD	V_{LCD}	Ta=-20□	—	—	—	V
		Ta=25□	—	4.5	—	V
		Ta=70□	—	—	—	V
Input High Volt.	V_{IH}	—	0.7 V_{DD}	—	V_{DD}	V
Input Low Volt.	V_{IL}	—	—	—	0.2 V_{DD}	V
Output High Volt.	V_{OH}	—	0.7V_{DD}	—	—	V
Output Low Volt.	V_{OL}	—	—	—	0.8	V
Supply Current (No include LED Backlight)	IDD	—	—	0.2	—	mA

Please kindly consider to design the Vop to be adjustable while programing the software to match LCD contrast tolerance.

7. Backlight Information

Specification

PARAMETER	SYMBOL	MIN	TYP	MAX	UNIT	TEST CONDITION
Supply Current	ILED	—	32	40	mA	V=3.5V
Supply Voltage	V	3.4	3.5	3.6	V	—
Reverse Voltage	VR	—	—	5	V	—
Range	X	0.27	0.29	0.31		ILED=32mA
	Y	0.28	0.30	0.32		
Luminance (Without LCD)	IV	616	770	—	CD/M^2	ILED=32mA
LED Life Time (For Reference only)	—	—	50000	—	Hr.	ILED=32mA 25°C, 50-60%RH, (Note 1)
Color	White					

Note: The LED of B/L is drive by current only, drive voltage is for reference only.
drive voltage can make driving current under safety area (current between minimum and maximum).

Note 1: 50000 hours is only an estimate for reference.

LED B\L Drive Method
1.Drive from A , K

R
A
B/L
K
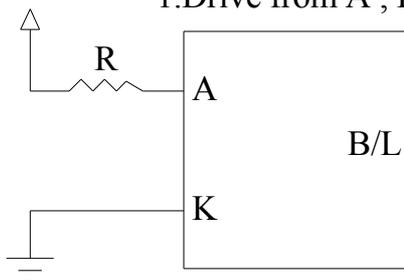
8. Reliability

Content of Reliability Test (Wide temperature, -20°C~+70°C)

Environmental Test			
Test Item	**Content of Test**	**Test Condition**	**Note**
High Temperature storage	Endurance test applying the high storage temperature for a long time.	+80°C 200hrs	2
Low Temperature storage	Endurance test applying the low storage temperature for a long time.	-30°C 200hrs	1,2
High Temperature Operation	Endurance test applying the electric stress (Voltage & Current) and the thermal stress to the element for a long time.	+70°C 200hrs	___
Low Temperature Operation	Endurance test applying the electric stress under low temperature for a long time.	-20°C 200hrs	1
High Temperature/ Humidity storage	The module should be allowed to stand at 60□,90%RH max For 96hrs under no-load condition excluding the polarizer, Then taking it out and drying it at normal temperature.	+60°C,90%RH 96hrs	1,2
Thermal shock resistance	The sample should be allowed stand the following 10 cycles of operation -20°C　+25°C　+70°C 30min　5min　30min 1 cycle	-20°C/+70°C 10 cycles	___
Vibration test	Endurance test applying the vibration during transportation and using.	Total fixed amplitude : 1.5mm Vibration Frequency : 10~55Hz One cycle 60 seconds to 3 directions of X,Y,Z for Each 15 minutes	3
Static electricity test	Endurance test applying the electric stress to the terminal.	VS=±600V(Contact), ±800v(Air), RS=330Ω CS=150pF 10 times	___

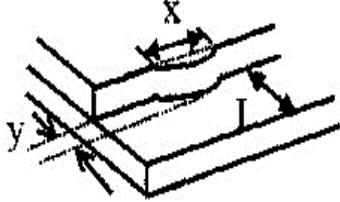Note1: No dew condensation to be observed.

Note2: The function test shall be conducted after 4 hours storage at the normal

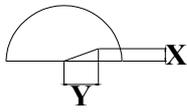   Temperature and humidity after remove from the test chamber.

Note3: The packing have to including into the vibration testing.

9. Inspection specification

NO	Item	Criterion	AQL
01	Electrical Testing	1.1 Missing vertical, horizontal segment, segment contrast defect. 1.2 Missing character , dot or icon. 1.3 Display malfunction. 1.4 No function or no display. 1.5 Current consumption exceeds product specifications. 1.6 LCD viewing angle defect. 1.7 Mixed product types. 1.8 Contrast defect.	0.65
02	Black or white spots on LCD (display only)	2.1 White and black spots on display $\leqq$0.25mm, no more than three white or black spots present. 2.2 Densely spaced: No more than two spots or lines within 3mm	2.5
03	LCD black spots, white spots, contamination (non-display)	3.1 Round type : As following drawing $\Phi=(x + y) / 2$ <table><tr><td>SIZE</td><td>Acceptable Q TY</td></tr><tr><td>$\Phi\leqq0.10$</td><td>Accept no dense</td></tr><tr><td>$0.10<\Phi\leqq0.20$</td><td>2</td></tr><tr><td>$0.20<\Phi\leqq0.25$</td><td>1</td></tr><tr><td>$0.25<\Phi$</td><td>0</td></tr></table> 3.2 Line type : (As following drawing) <table><tr><td>Length</td><td>Width</td><td>Acceptable Q TY</td></tr><tr><td>---</td><td>$W\leqq0.02$</td><td>Accept no dense</td></tr><tr><td>$L\leqq3.0$</td><td>$0.02<W\leqq0.03$</td><td rowspan="2">2</td></tr><tr><td>$L\leqq2.5$</td><td>$0.03<W\leqq0.05$</td></tr><tr><td>---</td><td>$0.05<W$</td><td>As round type</td></tr></table>	2.5 2.5
04	Polarizer bubbles	If bubbles are visible, judge using black spot specifications, not easy to find, must check in specify direction. <table><tr><td>Size Φ</td><td>Acceptable Q TY</td></tr><tr><td>$\Phi\leqq0.20$</td><td>Accept no dense</td></tr><tr><td>$0.20<\Phi\leqq0.50$</td><td>3</td></tr><tr><td>$0.50<\Phi\leqq1.00$</td><td>2</td></tr><tr><td>$1.00<\Phi$</td><td>0</td></tr><tr><td>Total Q TY</td><td>3</td></tr></table>	2.5
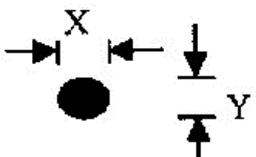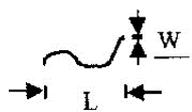
NO	Item	Criterion	AQL
05	Scratches	Follow NO.3 LCD black spots, white spots, contamination	
06	Chipped glass	Symbols Define: x: Chip length y: Chip width z: Chip thickness k: Seal width t: Glass thickness a: LCD side length L: Electrode pad length: 6.1 General glass chip : 6.1.1 Chip on panel surface and crack between panels:	2.5
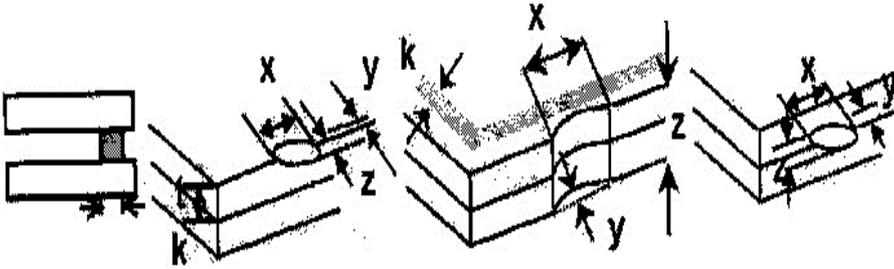
z: Chip thickness	y: Chip width	x: Chip length
$Z \leqq 1/2t$	Not over viewing area	$x \leqq 1/8a$
$1/2t < z \leqq 2t$	Not exceed $1/3k$	$x \leqq 1/8a$

⊙If there are 2 or more chips, x is total length of each chip.

6.1.2 Corner crack:
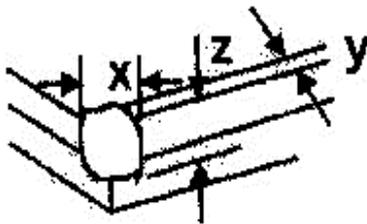
z: Chip thickness	y: Chip width	x: Chip length
$Z \leqq 1/2t$	Not over viewing area	$x \leqq 1/8a$
$1/2t < z \leqq 2t$	Not exceed $1/3k$	$x \leqq 1/8a$

⊙If there are 2 or more chips, x is the total length of each chip.

NO	Item	Criterion	AQL
06	Glass crack	Symbols : x: Chip length y: Chip width z: Chip thickness k: Seal width t: Glass thickness a: LCD side length L: Electrode pad length 6.2 Protrusion over terminal : 6.2.1 Chip on electrode pad : 	2.5

<div align="center">
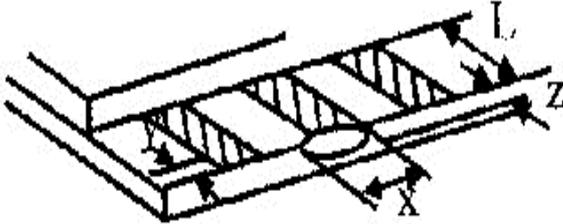
y: Chip width	x: Chip length	z: Chip thickness
$y \leqq 0.5mm$	$x \leqq 1/8a$	$0 < z \leqq t$

</div>

6.2.2 Non-conductive portion:

<div align="center">
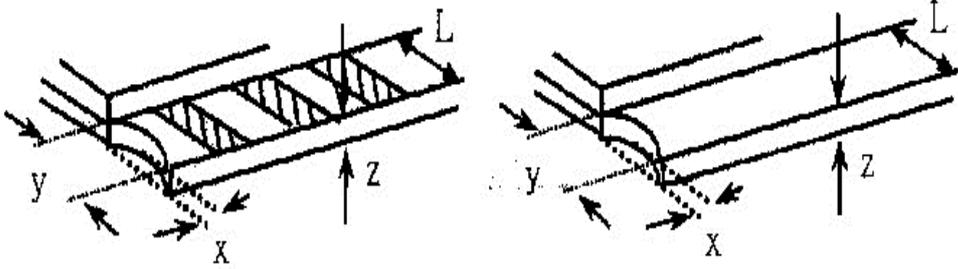
y: Chip width	x: Chip length	z: Chip thickness
$y \leqq L$	$x \leqq 1/8a$	$0 < z \leqq t$

</div>

⊙If the chipped area touches the ITO terminal, over 2/3 of the ITO
  must remain and be inspected according to electrode terminal
  specifications.

⊙If the product will be heat sealed by the customer, the alignment
  mark not be damaged.

6.2.3 Substrate protuberance and internal crack.

<div align="center">

y: width	x: length
$y \leqq 1/3L$	$x \leqq a$

</div>

NO	Item	Criterion	AQL
07	Cracked glass	The LCD with extensive crack is not acceptable.	2.5
08	Backlight elements	8.1 Illumination source flickers when lit.	0.65
		8.2 Spots or scratched that appear when lit must be judged. Using LCD spot, lines and contamination standards.	2.5
		8.3 Backlight doesn't light or color wrong.	0.65
09	Bezel	9.1 Bezel may not have rust, be deformed or have fingerprints, stains or other contamination.	2.5
		9.2 Bezel must comply with job specifications.	0.65
10	PCB、COB	10.1 COB seal may not have pinholes larger than 0.2mm or contamination.	2.5
		10.2 COB seal surface may not have pinholes through to the IC.	
		10.3 The height of the COB should not exceed the height indicated in the assembly diagram.	2.5
			0.65
		10.4 There may not be more than 2mm of sealant outside the seal area on the PCB. And there should be no more than three places.	2.5
		10.5 No oxidation or contamination PCB terminals.	
		10.6 Parts on PCB must be the same as on the production characteristic chart. There should be no wrong parts, missing parts or excess parts.	2.5
			0.65
		10.7 The jumper on the PCB should conform to the product characteristic chart.	
		10.8 If solder gets on bezel tab pads, LED pad, zebra pad or screw hold pad, make sure it is smoothed down.	0.65
		10.9 The Scraping testing standard for Copper Coating of PCB	2.5
		X * Y<=2mm2	2.5
11	Soldering	11.1 No un-melted solder paste may be present on the PCB.	2.5
		11.2 No cold solder joints, missing solder connections, oxidation or icicle.	2.5
		11.3 No residue or solder balls on PCB.	2.5
		11.4 No short circuits in components on PCB.	0.65

NO	Item	Criterion	AQL
12	General appearance	12.1 No oxidation, contamination, curves or, bends on interface Pin (OLB) of TCP.	2.5
		12.2 No cracks on interface pin (OLB) of TCP.	0.65
		12.3 No contamination, solder residue or solder balls on product.	2.5
		12.4 The IC on the TCP may not be damaged, circuits.	2.5
		12.5 The uppermost edge of the protective strip on the interface pin must be present or look as if it cause the interface pin to sever.	2.5
		12.6 The residual rosin or tin oil of soldering (component or chip component) is not burned into brown or black color.	2.5
		12.7 Sealant on top of the ITO circuit has not hardened.	2.5
		12.8 Pin type must match type in specification sheet.	0.65
		12.9 LCD pin loose or missing pins.	0.65
		12.10 Product packaging must the same as specified on packaging specification sheet.	0.65
		12.11 Product dimension and structure must conform to product specification sheet.	0.65
		12.12 Visual defect outside of VA is not considered to be rejection.	

10. Precautions in use of LCD Modules

(1) Avoid applying excessive shocks to the module or making any alterations or modifications to it.

(2) Don't make extra holes on the printed circuit board, modify its shape or change the components of LCD module.

(3) Don't disassemble the LCM.

(4) Don't operate it above the absolute maximum rating.

(5) Don't drop, bend or twist LCM.

(6) Soldering: only to the I/O terminals.

(7) Storage: please storage in anti-static electricity container and clean environment.

(8) DISPLAY have the right to change the passive components, including R3,R6 & backlight adjust resistors. (Resistors,capacitors and other passive components will have different appearance and color caused by the different supplier.)

(9) DISPLAY have the right to change the PCB Rev. (In order to satisfy the supplying stability, management optimization and the best product performance...etc, under the premise of not affecting the electrical characteristics and external dimensions, DISPLAY have the right to modify the version.)

(10) To ensure the stability of the display screen, please apply screen saver after showing 30 minutes of fixed display content.